

TFT LCD Module SPECIFICATION

Customer: _____
Model Name: TI035AI300
SPEC NO.: _____
Date: 2025.05.28
Version: V02

- Preliminary Specification
 Final Specification

For Customer's Acceptance

Approved by	Comment

Approved by	Reviewed by	Prepared by

Record of Revision

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Version	Revise Date	Page	Content
V02	20250528	12	Add Pin 5,6,43,44 Pin definition

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1. General Description

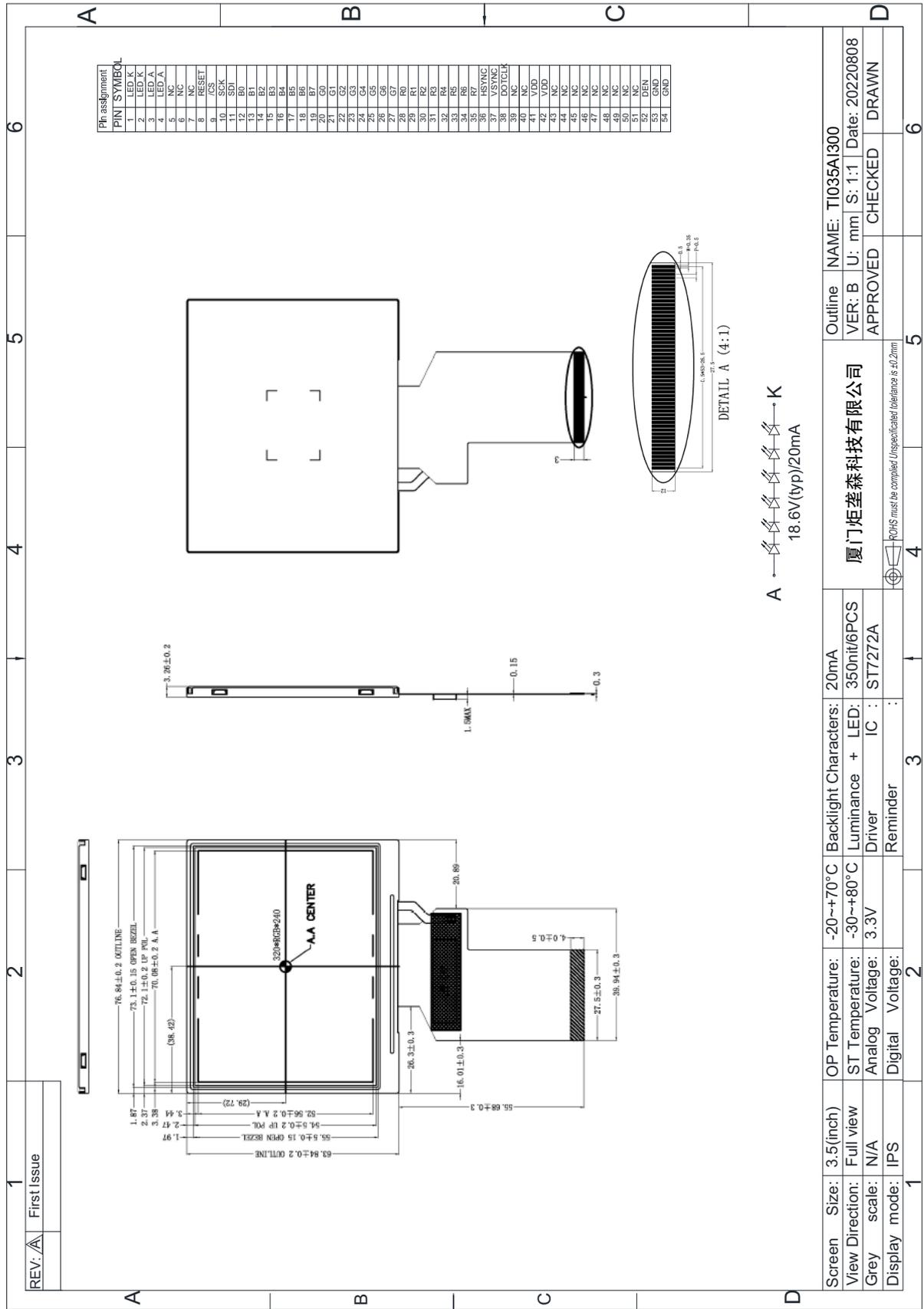
The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver Ics and a backlight unit.

2. Module Parameter

Features	Details	Unit
Display Size(Diagonal)	3.5"	
LCD type	a-Si TFT	
Display Mode	Transmissive /Normally black	
Resolution	320 RGB x 240	Pixels
View Direction	FULL VIEW	Best Image
Module Outline	76.9(H) x 63.9(V) x 3.3(T) (Note1)	mm
Active Area	70.08(H) x 52.56(V)	mm
Pixel Size	219(H) x219(V)	um
Pixel Arrangement	RGB vertical stripe	
Polarizer Surface Treatment	Glare	
Display Colors	16.7M	
Interface	24-bit RGB Interface+3 wire SPI	
Driver IC	ST7272A	-
With or Without Touch Panel	Without	
Operating Temperature	-20~70	°C
Storage Temperature	-30~80	°C
Weight	TBD	g

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

2.1. Outline Drawing



3. Absolute Maximum Ratings

 $V_{SS}=0V, T_a=25^{\circ}C$

Item	Symbol	Min.	Max.	Unit
Supply Voltage	VCC	-0.3	4.6	V
Storage temperature	T _{STG}	-30	+80	°C
Operating temperature	T _{OP}	-20	+70	°C

Note 1: If T_a below $50^{\circ}C$, the maximal humidity is 90%RH, if T_a over $50^{\circ}C$, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around $-10^{\circ}C$, and the back ground will become darker at high temperature operating.

4. DC Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit	
Supply Voltage	VDD	3.0	3.3	3.6	V	
Logic Low input voltage	V _{IL}	0	-	0.3*VDD	V	
Logic High input voltage	V _{IH}	0.7*VDD	-	VDD	V	
Logic Low output voltage	V _{OL}	GND	-	VDD+0.4	V	
Logic High output voltage	V _{OH}	VDD-0.4	-	VDD	V	
Current Consumption All Black	Logic	I _{CC+ I_{IN}}	-	TBD	-	mA
	Analog					

5. Backlight Characteristic

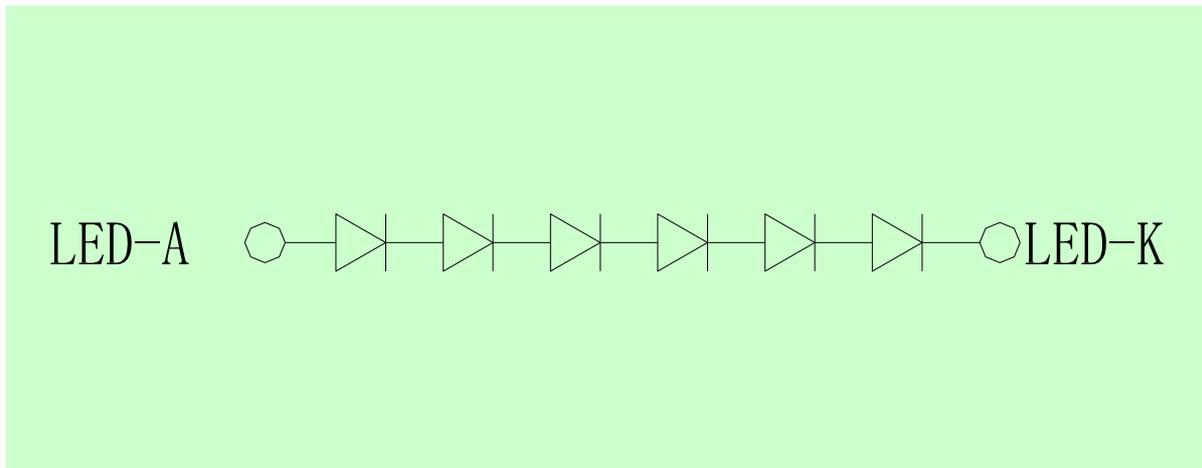
5.1. Backlight Characteristics

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V _F	T _a =25 °C, I _F =20mA/LED	16.8	18.6	20.4	V
Forward Current	I _F	T _a =25 °C, V _F =3.0 V/LED	-	20		mA
Power dissipation	P _D		-	372		mW
Uniformity	Avg		-	80	-	%
LED working life(25°C)	-		-	20,000	-	Hrs
Drive method	Constant current					
LED Configuration	6 White LEDs in parallel					

Note1: LED life time defined as follows: The final brightness is at 50% of original brightness.

The environmental conducted under ambient air flow, at $T_a=25\pm 2^{\circ}C, 60\%RH\pm 5\%$, $I_F=20mA$

5.2. Backlighting circuit

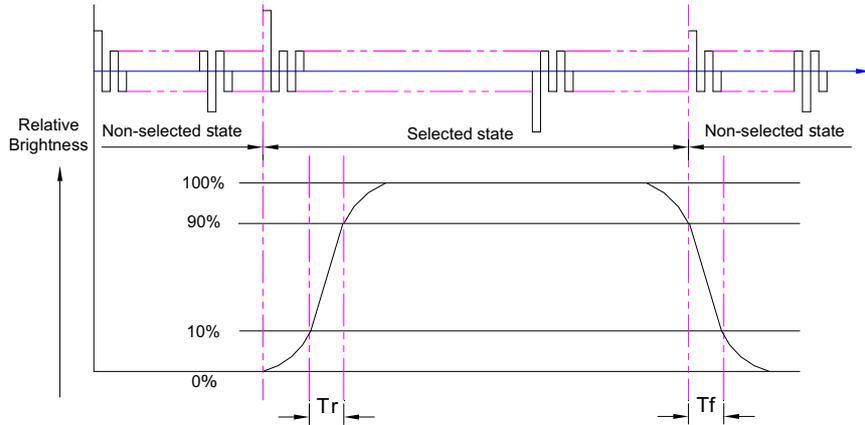


6. Optical Characteristics

6.1. Optical Characteristics

 $T_a=25^{\circ}\text{C}, V_{DD}=2.8\text{V}$

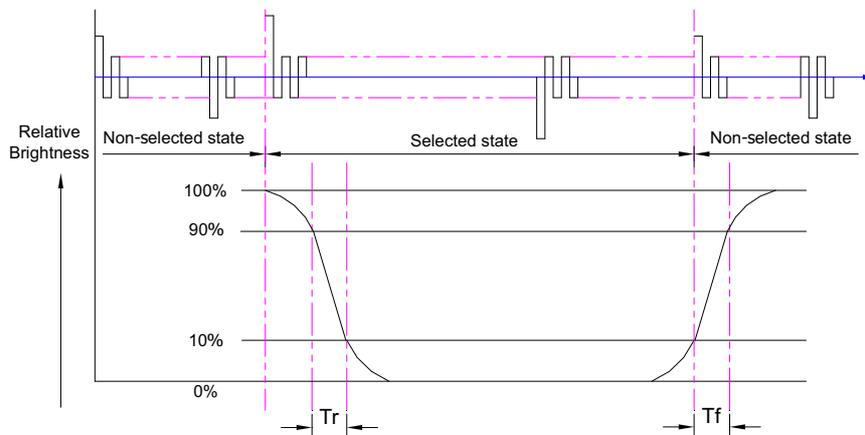
	Item	Symbol	Condition	Specification			Unit	
				Min.	Typ.	Max.		
Backlight On (Transmissive Mode)	Luminance on TFT($I_f=20\text{mA/LED}$)	L_v	Normally viewing angle $\theta_x = \phi_y = 0^{\circ}$	280	350	-	cd/m^2	
	Contrast ratio(See 6.3)	CR		640	800	-		
	Response time (See 6.2)	T_{R+TF}		-	30	40	ms	
	Chromaticity Transmissive (See 6.5)	Red	X_R	Center $CR \geq 10$		TBD		
			Y_R			TBD		
		Green	X_G			TBD		
			Y_G			TBD		
		Blue	X_B			TBD		
			Y_B			TBD		
	White	X_W		TBD				
Y_W			TBD					
Viewing Angle (See 6.4)	Horizontal	θ_{x+}	Center $CR \geq 10$	70	80	-	Deg.	
		θ_{x-}		70	80	-		
	Vertical	ϕ_{y+}		70	80	-		
		ϕ_{y-}		70	80	-		
	NTSC Ratio(Gamut)			50	55	-	%	

6.2. Definition of Response Time
6.2.1. Normally Black Type (Negative)


T_r is the time it takes to change from non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

T_f is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note: Measuring machine: LCD-5100

6.2.2. Normally White Type (Positive)


T_r is the time it takes to change from non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

T_f is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

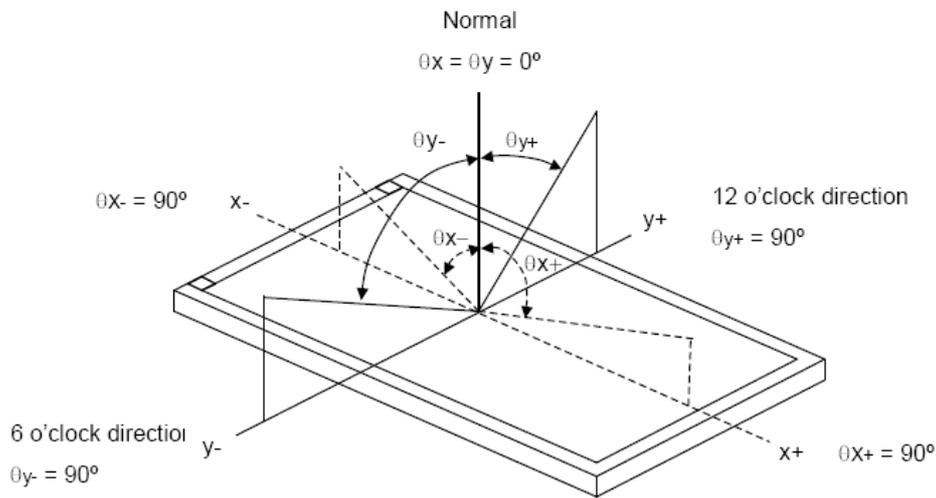
Note: Measuring machine: LCD-5100 or EQUI

6.3. Definition of Contrast Ratio

Contrast is measured perpendicular to display surface in reflective and transmissive mode. The measurement condition is:

Measuring Equipment	Eldim or Equivalent
Measuring Point Diameter	3mm//1mm
Measuring Point Location	Active Area centre point
Test pattern	A: All Pixels white
	B: All Pixel black
Contrast setting	Maximum

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

6.4. Definition of Viewing Angles


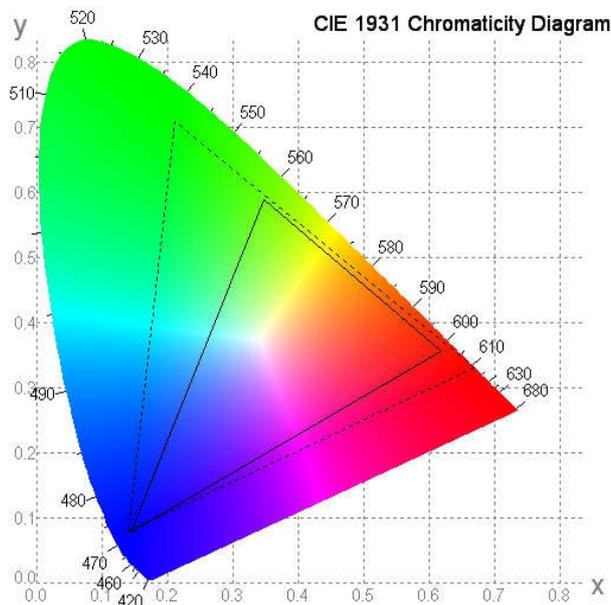
Measuring machine: LCD-5100 or EQUI

6.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram

NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)



6.6. Definition of Surface Luminance, Uniformity and Transmittance

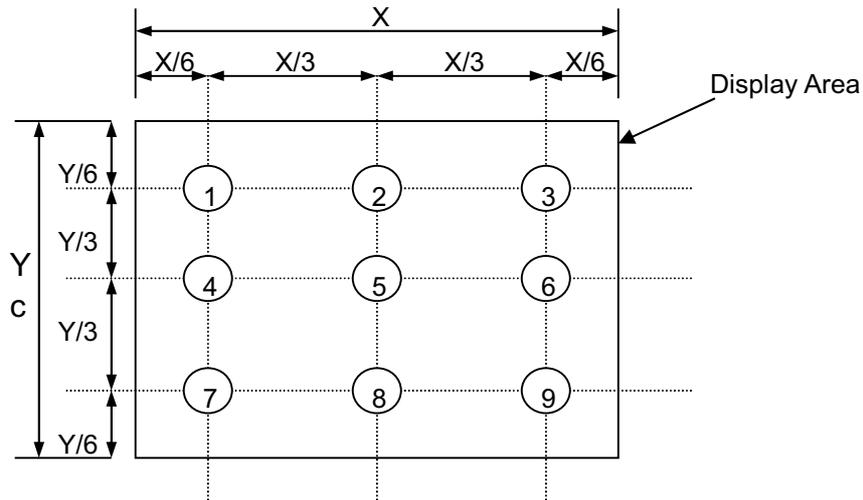
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

6.6.1. Surface Luminance: $L_v = \text{average} (L_{P1}:L_{P9})$

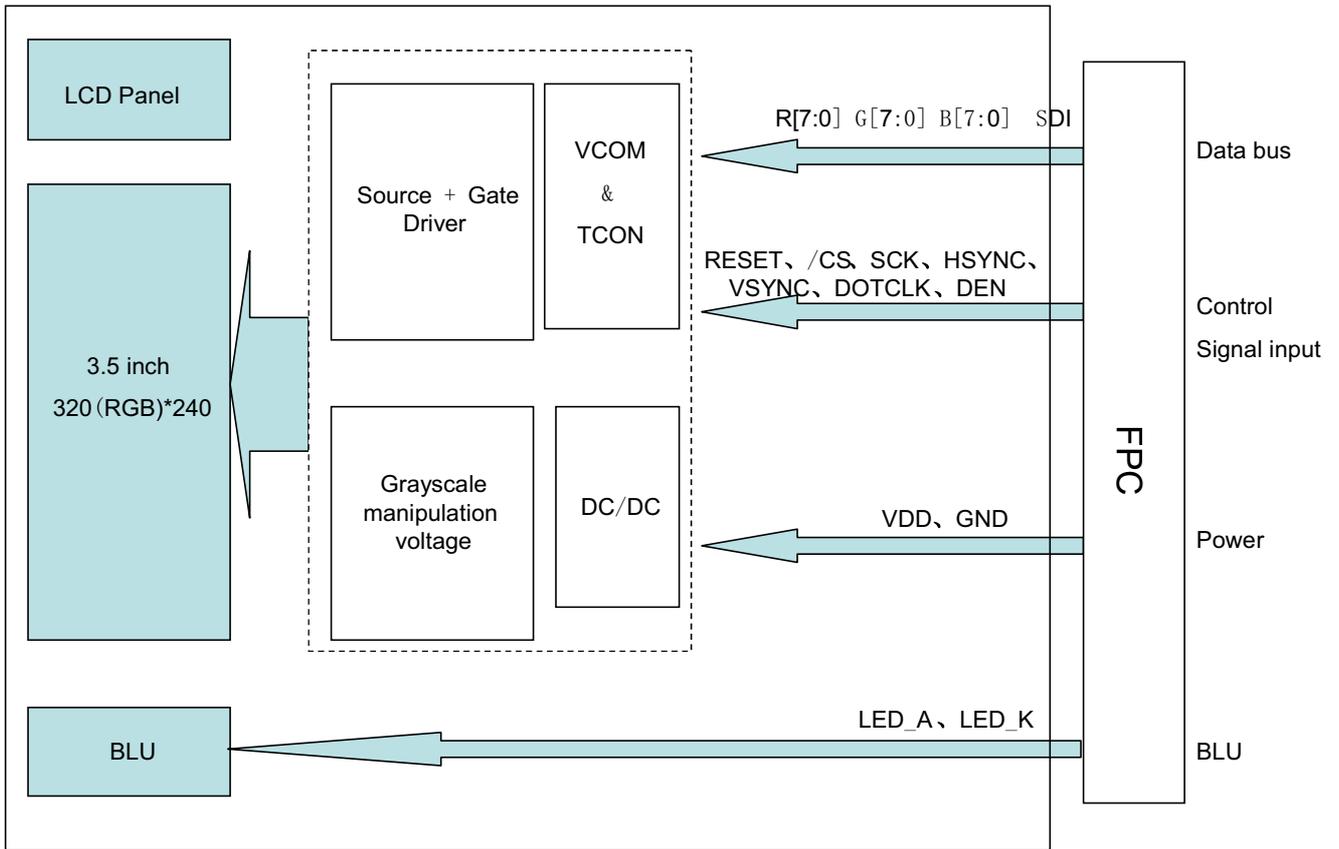
6.6.2. Uniformity = $\text{Minimal} (L_{P1}:L_{P9}) / \text{Maximal} (L_{P1}:L_{P9}) * 100\%$

6.6.3. Transmittance = $L_v \text{ on LCD} / L_v \text{ on Backlight} * 100\%$

Note: Measuring machine: BM-7



7. Block Diagram and Power Supply

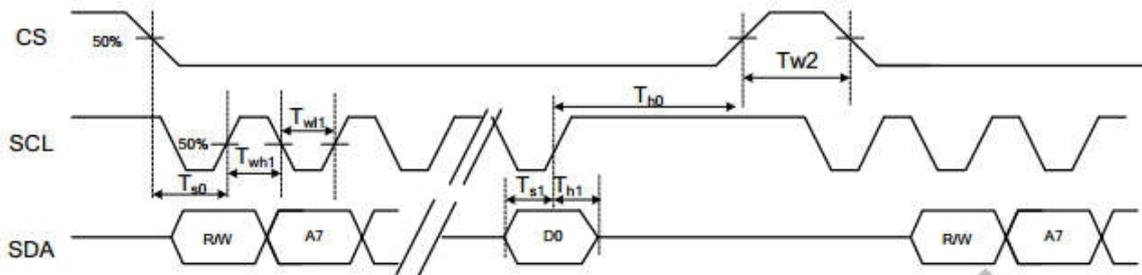


8. Interface Pins Definition

No.	Symbol	Function	Remark
1-2	LED_ K	LED cathode	
3-4	LED_ A	LED anode	
5-7	NC	No connect (5→Y1,6→X1 If connected to a resistive touch panel)	
8	RESET	Reset signal, Low active	
9	/CS	Chip select	
10	SCK	SPI Serial Clock	
11	SDI	SPI Serial Data Input/output	
12	B0	Data bus	
13	B1	Data bus	
14	B2	Data bus	
15	B3	Data bus	
16	B4	Data bus	
17	B5	Data bus	
18	B6	Data bus	
19	B7	Data bus	
20	G0	Data bus	
21	G1	Data bus	
22	G2	Data bus	
23	G3	Data bus	
24	G4	Data bus	
25	G5	Data bus	
26	G6	Data bus	
27	G7	Data bus	
28	R0	Data bus	
29	R1	Data bus	
30	R2	Data bus	
31	R3	Data bus	
32	R4	Data bus	
33	R5	Data bus	
34	R6	Data bus	
35	R7	Data bus	
36	HSYNC	Horizontal Synchronous Signal	
37	VSYNC	Vertical Synchronous Signal	
38	DOTCLK	Data Clock	
39-40	NC	No connect	
41-42	VDD	Power Supply	
43-51	NC	No connect (43→Y2,44→X2 ,If connected to a resistive touch panel)	
52	DEN	Data enabling signal	
53-54	GND	Ground	

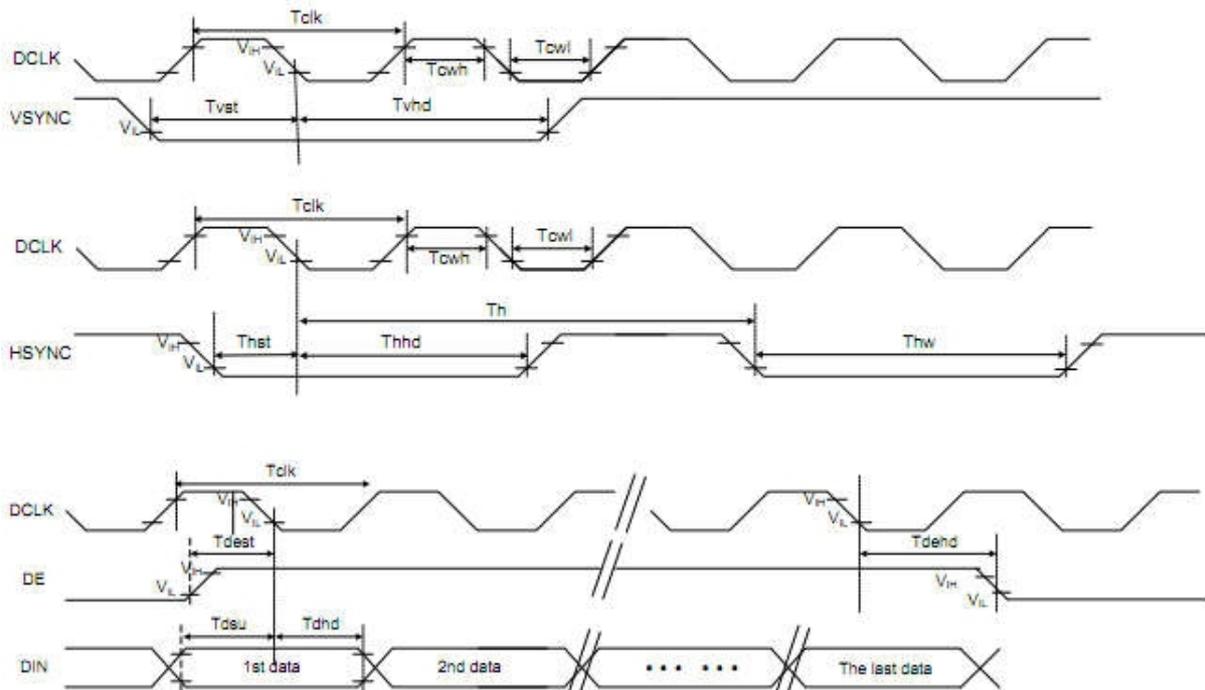
9. AC Characteristics

9.1. System Bus Timing for 3-Wire SPI Interface

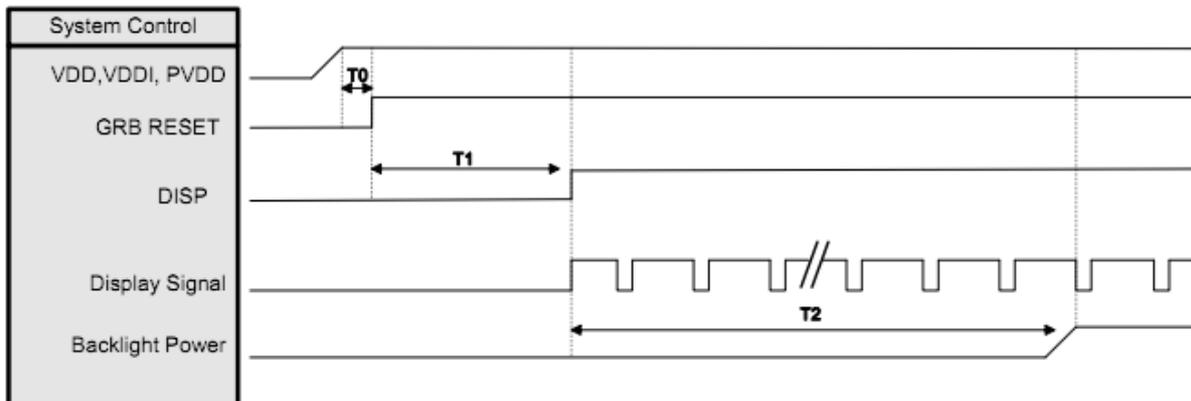


Item	Symbol	Min.	Typ.	Max.	Unit	Conditions
CS Input Setup Time	Ts0	50	-	-	ns	
Serial Data Input Setup Time	Ts1	50	-	-	ns	
CS Input Hold Time	Th0	50	-	-	ns	
Serial Data Input Hold Time	Th1	50	-	-	ns	
SCL Write Pulse High Width	Twh1	50	-	-	ns	
SCL Write Pulse Low Width	Twl1	50	-	-	ns	
SCL Read Pulse High Width	Trh1	300			ns	
SCL Read Pulse Low Width	Trl1	300			ns	
CS Pulse High Width	Tw2	400	-	-	ns	

9.2. System Bus Timing for RGB Interface

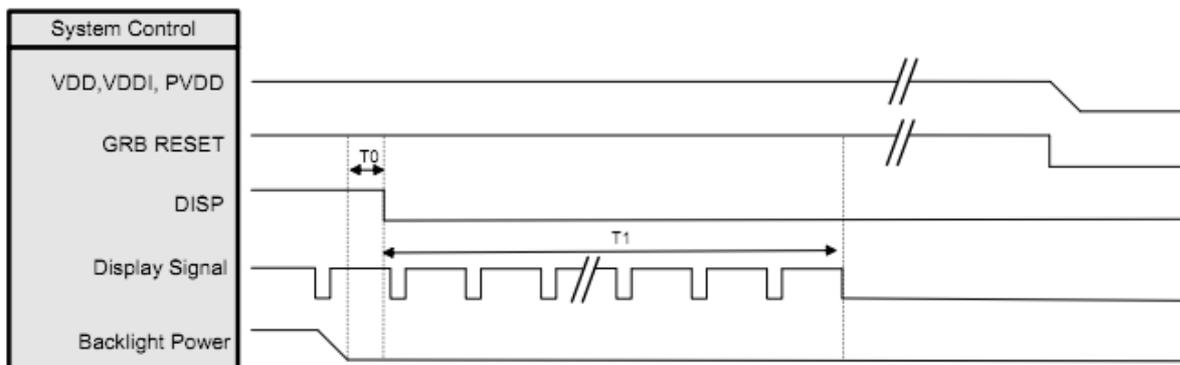


Item	Symbol	Min.	Typ.	Max.	Unit	Conditions
CLK Pulse Duty	Tclk	40	50	60	%	
HSYNC Width	Thw	2	-	-	DCLK	
HSYNC Period	Th	55	60	65	us	
VSYNC Setup Time	Tvst	12	-	-	ns	
VSYNC Hold Time	Tvhd	12	-	-	ns	
HSYNC Setup Time	Thst	12	-	-	ns	
HSYNC Hold Time	Thhd	12	-	-	ns	
Data Setup Time	Tdsu	12	-	-	ns	
Data Hold Time	Tdhd	12	-	-	ns	
DE Setup Time	Tdest	12	-	-	ns	
DE Hold Time	Tdehd	12	-	-	ns	

10. POWER ON/OFF SEQUENCE
10.1. Power On Sequence


Symbol	Description	Min. Time	Unit
T0	System power stability to GRB RESET signal	0	ms
T1	GRB RESET= "High" to DISP="High"	10	ms
T2	Display Signal output to Backlight Power on	250	ms

Note: Display signal: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DG[7:0]; DB[7:0]

10.2. Power Off Sequence


Symbol	Description	Min. Time	Unit
T0	Backlight Power off to DISP="Low"	5	ms
T1	DISP="Low" to IC internal voltage discharge complete	80	ms

Note: Display signal: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DG[7:0]; DB[7:0]

11. Quality Assurance

11.1. Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

11.2. Standard for Quality Test

11.2.1 Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II

11.2.2 Sampling Criteria:

Visual inspection: AQL 1.5%

Electrical functional: AQL 0.65%.

11.2.3 Reliability Test:

Detailed requirement refer to Reliability Test Specification.

11.3. Nonconforming Analysis & Disposition

11.3.1 Nonconforming analysis:

11.3.1.1 Customer should provide overall information of non-conforming sample for their complaints.

11.3.1.2 After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.

11.3.1.3 If cannot finish the analysis on time, customer will be notified with the progress status.

11.3.2 Disposition of nonconforming:

11.3.2.1 Non-conforming product over PPM level will be replaced.

11.3.2.2 The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

11.4. Agreement Items

Shall negotiate with customer if the following situation occurs:

11.4.1 There is any discrepancy in standard of quality assurance.

11.4.2 Additional requirement to be added in product specification.

11.4.3 Any other special problem.

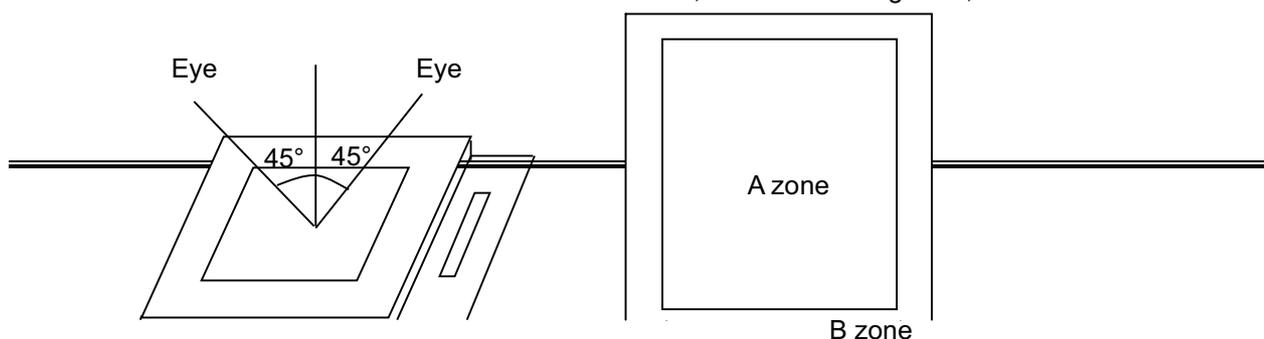
11.5. Standard of the Product Visual Inspection

11.5.1 Appearance inspection:

11.5.1.1 The inspection must be under illumination about 1000 – 1500 lx, and the distance of view must be at 30cm ± 2cm.

11.5.1.2 The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

11.5.1.3 Definition of area: A Zone: Active Area, B Zone: Viewing Area,

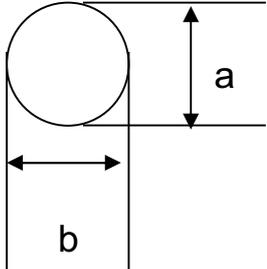
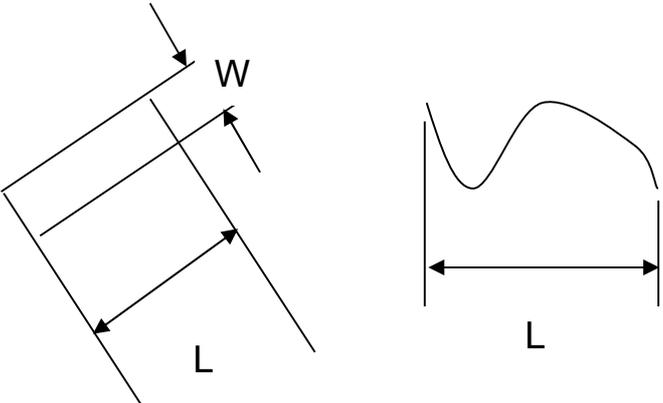


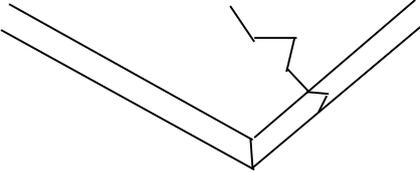
11.5.2 Basic principle:

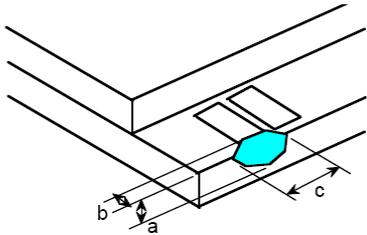
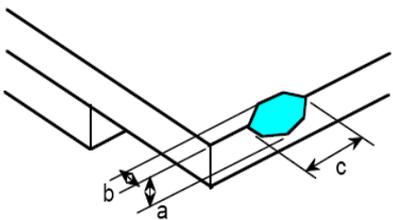
11.5.2.1 A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.

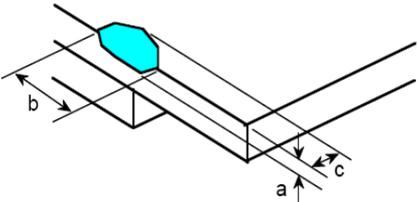
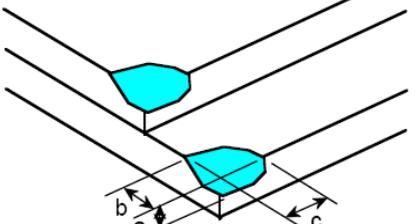
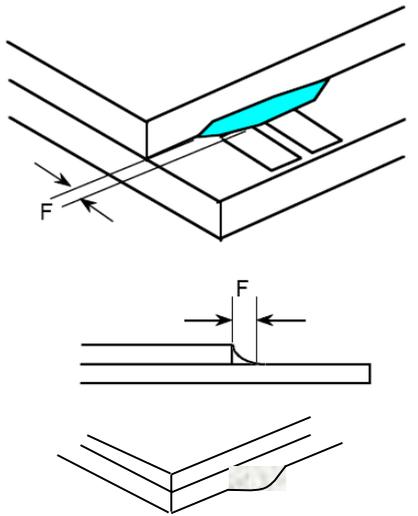
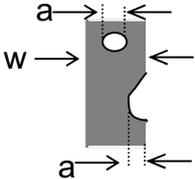
11.5.2.2 New item must be added on time when it is necessary.

11.6. Inspection Specification

No.	Item	Criteria (Unit: mm)																	
01	Black / White spot Foreign material (Round type) Pinholes Stain Particles inside cell. (Minor defect)	 <div style="display: flex; justify-content: space-around; align-items: center;"> <table border="1" style="border-collapse: collapse; text-align: center;"> <thead> <tr> <th>Size \ Area</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>≤ 0.10</td> <td>Ignore</td> </tr> <tr> <td>$0.10 < \leq 0.15$</td> <td>2</td> </tr> <tr> <td>$0.15 < \leq 0.25$</td> <td>1</td> </tr> <tr> <td>$0.25 <$</td> <td>0</td> </tr> <tr> <td>Total</td> <td>2 no include ≤ 0.10</td> </tr> </tbody> </table> </div> <p>$\phi = (a + b) / 2$</p> <p>Distance between 2 defects should more than 3mm apart.</p>	Size \ Area	Acc. Qty	≤ 0.10	Ignore	$0.10 < \leq 0.15$	2	$0.15 < \leq 0.25$	1	$0.25 <$	0	Total	2 no include ≤ 0.10					
Size \ Area	Acc. Qty																		
≤ 0.10	Ignore																		
$0.10 < \leq 0.15$	2																		
$0.15 < \leq 0.25$	1																		
$0.25 <$	0																		
Total	2 no include ≤ 0.10																		
02	Electrical Defect (Minor defect)	<table border="1" style="border-collapse: collapse; text-align: center;"> <thead> <tr> <th></th> <th>Display Area</th> <th>Total</th> <th rowspan="4">Note 1</th> </tr> </thead> <tbody> <tr> <td>Bright dot</td> <td>0</td> <td>0</td> </tr> <tr> <td>Dark dot</td> <td>$N \leq 2$</td> <td>$N \leq 2$</td> </tr> <tr> <td>Total dot</td> <td>$N \leq 2$</td> <td>$N \leq 2$</td> </tr> <tr> <td>Mura</td> <td colspan="2">Not visible through 5% ND filters .</td> <td>Note 2</td> </tr> </tbody> </table> <p>Remark: 1. Bright dot caused by scratch and foreign object accords to item 1.</p>		Display Area	Total	Note 1	Bright dot	0	0	Dark dot	$N \leq 2$	$N \leq 2$	Total dot	$N \leq 2$	$N \leq 2$	Mura	Not visible through 5% ND filters .		Note 2
	Display Area	Total	Note 1																
Bright dot	0	0																	
Dark dot	$N \leq 2$	$N \leq 2$																	
Total dot	$N \leq 2$	$N \leq 2$																	
Mura	Not visible through 5% ND filters .		Note 2																
03	Black and White line Scratch Foreign material (Line type) (Minor defect)																		

		<table border="1"> <thead> <tr> <th>Length</th> <th>Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>/</td> <td>$W \leq 0.03$</td> <td>Ignore</td> </tr> <tr> <td>$L \leq 2.5$</td> <td>$0.03 < W \leq 0.05$</td> <td>3</td> </tr> <tr> <td>$L \leq 2.5$</td> <td>$0.05 < W \leq 0.10$</td> <td>2</td> </tr> <tr> <td>/</td> <td>$0.1 < W$</td> <td>0</td> </tr> <tr> <td colspan="2" style="text-align: center;">otal</td> <td>3</td> </tr> </tbody> </table> <p>Distance between 2 defects should more than 3mm apart. Scratches not viewable through the back of the display are acceptable.</p>	Length	Width	Acc. Qty	/	$W \leq 0.03$	Ignore	$L \leq 2.5$	$0.03 < W \leq 0.05$	3	$L \leq 2.5$	$0.05 < W \leq 0.10$	2	/	$0.1 < W$	0	otal		3
Length	Width	Acc. Qty																		
/	$W \leq 0.03$	Ignore																		
$L \leq 2.5$	$0.03 < W \leq 0.05$	3																		
$L \leq 2.5$	$0.05 < W \leq 0.10$	2																		
/	$0.1 < W$	0																		
otal		3																		
04	Glass Crack (Minor defect)	 <p>Crack is potential to enlarge, any type is not allowed.</p>																		

05	Glass Chipping Pad Area: (Minor defect)	 <table border="1"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c > 3.0, b < 1.0$</td> <td>1</td> </tr> <tr> <td>$c < 3.0, b < 1.0$</td> <td>3</td> </tr> <tr> <td colspan="2" style="text-align: center;">$a < \text{Glass Thickness}$</td> </tr> </tbody> </table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	3	$a < \text{Glass Thickness}$			
Length and Width	Acc. Qty											
$c > 3.0, b < 1.0$	1											
$c < 3.0, b < 1.0$	3											
$a < \text{Glass Thickness}$												
06	Glass Chipping Rear of Pad Area: (Minor defect)	 <table border="1"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c > 3.0, b < 1.0$</td> <td>1</td> </tr> <tr> <td>$c < 3.0, b < 1.0$</td> <td>2</td> </tr> <tr> <td>$c < 3.0, b < 0.5$</td> <td>4</td> </tr> <tr> <td colspan="2" style="text-align: center;">$a < \text{Glass Thickness}$</td> </tr> </tbody> </table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	2	$c < 3.0, b < 0.5$	4	$a < \text{Glass Thickness}$	
Length and Width	Acc. Qty											
$c > 3.0, b < 1.0$	1											
$c < 3.0, b < 1.0$	2											
$c < 3.0, b < 0.5$	4											
$a < \text{Glass Thickness}$												

07	<p>Glass Chipping Except Pad Area: (Minor defect)</p> 	<table border="1"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c > 3.0, b < 1.0$</td> <td>1</td> </tr> <tr> <td>$c < 3.0, b < 1.0$</td> <td>2</td> </tr> <tr> <td>$c < 3.0, b < 0.5$</td> <td>4</td> </tr> <tr> <td colspan="2" style="text-align: center;">$a < \text{Glass Thickness}$</td> </tr> </tbody> </table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	2	$c < 3.0, b < 0.5$	4	$a < \text{Glass Thickness}$	
Length and Width	Acc. Qty											
$c > 3.0, b < 1.0$	1											
$c < 3.0, b < 1.0$	2											
$c < 3.0, b < 0.5$	4											
$a < \text{Glass Thickness}$												
08	<p>Glass Corner Chipping: (Minor defect)</p> 	<table border="1"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c < 3.0, b < 3.0$</td> <td>Ignore</td> </tr> <tr> <td colspan="2" style="text-align: center;">$a < \text{Glass Thickness}$</td> </tr> </tbody> </table>	Length and Width	Acc. Qty	$c < 3.0, b < 3.0$	Ignore	$a < \text{Glass Thickness}$					
Length and Width	Acc. Qty											
$c < 3.0, b < 3.0$	Ignore											
$a < \text{Glass Thickness}$												
09	<p>Glass Burr: (Minor defect)</p> 	<table border="1"> <thead> <tr> <th>Length</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$F < 1.0$</td> <td>Ignore</td> </tr> </tbody> </table> <p>Glass burr don't affect assemble and module dimension.</p>	Length	Acc. Qty	$F < 1.0$	Ignore						
Length	Acc. Qty											
$F < 1.0$	Ignore											
10	<p>FPC Defect: (Minor defect)</p> 	<p>10.1 Dent, pinhole width $a < w/3$. (w: circuitry width.)</p> <p>10.2 Open circuit is unacceptable.</p> <p>10.3 No oxidation, contamination and distortion.</p>										

11	Bubble on Polarizer (Minor defect)	<table border="1" data-bbox="692 215 1161 430"> <thead> <tr> <th>Diameter</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$\varphi \leq 0.20$</td> <td>Ignore</td> </tr> <tr> <td>$0.20 < \varphi \leq 0.30$</td> <td>4</td> </tr> <tr> <td>$0.30 < \varphi \leq 0.50$</td> <td>1</td> </tr> <tr> <td>$0.50 < \varphi$</td> <td>None</td> </tr> </tbody> </table>	Diameter	Acc. Qty	$\varphi \leq 0.20$	Ignore	$0.20 < \varphi \leq 0.30$	4	$0.30 < \varphi \leq 0.50$	1	$0.50 < \varphi$	None
Diameter	Acc. Qty											
$\varphi \leq 0.20$	Ignore											
$0.20 < \varphi \leq 0.30$	4											
$0.30 < \varphi \leq 0.50$	1											
$0.50 < \varphi$	None											
12	Dent on Polarizer (Minor defect)	<table border="1" data-bbox="692 488 1161 703"> <thead> <tr> <th>Diameter</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$\varphi \leq 0.20$</td> <td>Ignore</td> </tr> <tr> <td>$0.20 < \varphi \leq 0.30$</td> <td>4</td> </tr> <tr> <td>$0.30 < \varphi \leq 0.50$</td> <td>1</td> </tr> <tr> <td>$0.50 < \varphi$</td> <td>None</td> </tr> </tbody> </table>	Diameter	Acc. Qty	$\varphi \leq 0.20$	Ignore	$0.20 < \varphi \leq 0.30$	4	$0.30 < \varphi \leq 0.50$	1	$0.50 < \varphi$	None
Diameter	Acc. Qty											
$\varphi \leq 0.20$	Ignore											
$0.20 < \varphi \leq 0.30$	4											
$0.30 < \varphi \leq 0.50$	1											
$0.50 < \varphi$	None											
13	Bezel	13.1 No rust, distortion on the Bezel. 13.2 No visible fingerprints, stains or other contamination.										
14	Touch Panel	D: Diameter W: width L: length 14.1 Spot: $D < 0.25$ is acceptable $0.25 \leq D \leq 0.4$ 2dots are acceptable and the distance between defects should more than 10 mm. $D > 0.4$ is unacceptable 14.2 Dent: $D > 0.40$ is unacceptable 14.3 Scratch: $W \leq 0.03, L \leq 10$ is acceptable, $0.03 < W \leq 0.10, L \leq 10$ is acceptable Distance between 2 defects should more than 10 mm. $W > 0.10$ is unacceptable.										
15	PCB	15.1 No distortion or contamination on PCB terminals. 15.2 All components on PCB must same as documented on the BOM/component layout. 15.3 Follow IPC-A-600F.										
16	Soldering	Follow IPC-A-610C standard										
17	Electrical Defect (Major defect)	The below defects must be rejected. 17.1 Missing vertical / horizontal segment, 17.2 Abnormal Display. 17.3 No function or no display. 17.4 Current exceeds product specifications. 17.5 LCD viewing angle defect. 17.6 No Backlight. 17.7 Dark Backlight.										

		17.8 Touch Panel no function.
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Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

11.7. Classification of Defects

11.7.1 Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.

11.7.2 Two minor defects are equal to one major in lot sampling inspection.

11.8. Identification/marketing criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

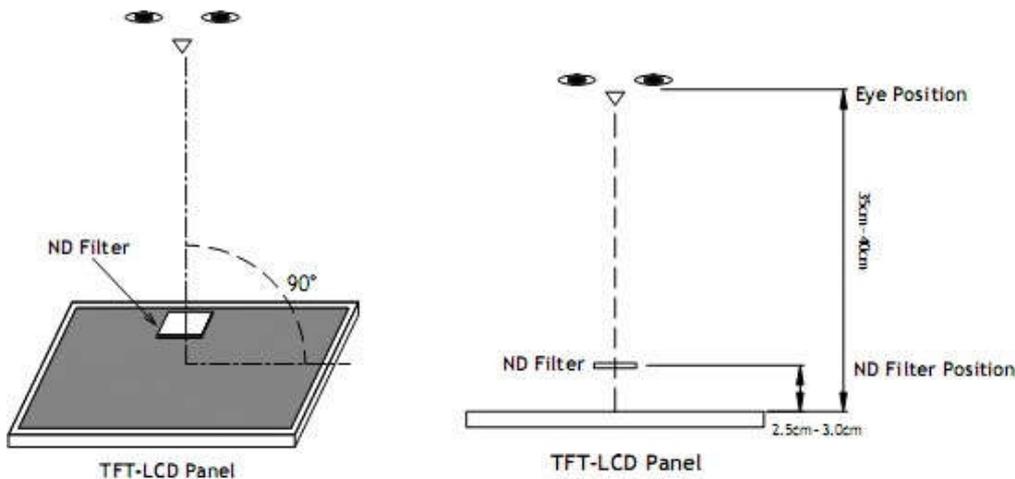
11.9. Packaging

11.9.1 There should be no damage of the outside carton box, each packaging box should have one identical label.

11.9.2 Modules inside package box should have compliant mark.

11.9.3 All direct package materials shall offer ESD protection

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is 350mm ± 50mm.

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is 350mm ± 50mm.

Note2: Mura on display which appears darker / brighter against background brightness on parts of display area.

12. Reliability Specification

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	70°C, 96Hrs	2	GB/T2423.2-2008
2	Low Temperature Operating	-20°C, 96Hrs	2	GB/T2423.1-2008
3	High Humidity	50°C, 90%RH, 96Hrs	2	GB/T2423.3-2006
4	High Temperature Storage	80°C, 96Hrs	2	GB/T2423.2-2008
5	Low Temperature Storage	-30°C, 96Hrs	2	GB/T2423.1-2008
6	Thermal Cycling Test	-20°C, 60min~70°C, 60min, 20 cycles.	2	GB/T2423.22-2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	2	GB/T5170.14-2009
8	Electrical Static Discharge	Air: ±4KV 150pF/330 Ω 5 times	2	GB/T17626.2-2006
		Contact: ±2KV 150pF/330 Ω 5 times		
9	Drop Test (Packaged)	Height:80 cm, 1 corner, 3 edges, 6 surfaces.	2	GB/T2423.8-1995

Note1. No deflection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value

13. Precautions and Warranty

13.1. Safety

13.1.1 The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

13.1.2 Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

13.2. Handling

13.2.1 Reverse and use within ratings in order to keep performance and prevent damage.

13.2.2 Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

13.3. Storage

13.3.1 Do not store the LCD module beyond the specified temperature ranges.

13.3.2 Strong light exposure causes degradation of polarizer and color filter.

13.4. Metal Pin (Apply to Products with Metal Pins)

13.4.1 Pins of LCD and Backlight

13.4.2.1 Solder tip can touch and press on the tip of Pin LEAD during the soldering

13.4.2.2 Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

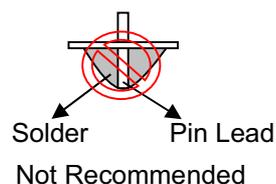
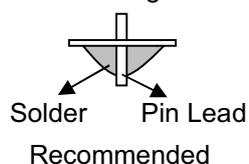
Maximum Solder Temperature: 370

Maximum Solder Time: 3s at the maximum temperature

Recommended Soldering Temp: 350±20

Typical Soldering Time: ≤3s

13.4.2.3 Solder Wetting



13.4.2 Pins of EL

13.4.2.1 Solder tip can touch and press on the tip of EL leads during soldering.

13.4.2.2 No Solder Paste on the soldering pad on the motherboard is recommended.

13.4.2.3 Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270~290

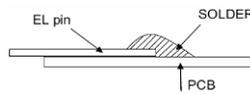
Typical Soldering Time: ≤2s

Minimum solder distance from EL lamp (body):2.0mm

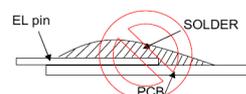
13.4.2.4 No horizontal press on the EL leads during soldering.

13.4.2.5 180° bend EL leads three times is not allowed.

13.4.2.6 Solder Wetting

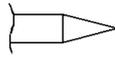


Recommended

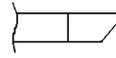


Not Recommended

13.4.2.7 The type of the solder iron:

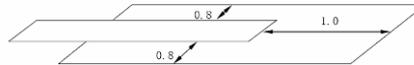


Recommended



Not Recommended

13.4.2.8 Solder Pad



13.5. Operation

13.5.1 Do not drive LCD with DC voltage

13.5.2 Response time will increase below lower temperature

13.5.3 Display may change color with different temperature

13.5.4 Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".

13.5.5 Do not connect or disconnect the LCM to or from the system when power is on.

13.5.6 Never use the LCM under abnormal condition of high temperature and high humidity.

13.5.7 Module has high frequency circuits. Sufficient suppression to the electromagnetic interface shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.

13.5.8 Do not display the fixed pattern for long time (we suggest the time not longer than half of one hour) because it may develop image sticking due to the TFT structure.

13.6. Static Electricity

13.6.1 CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.

13.6.2 The normal static prevention measures should be observed for work clothes and benches.

13.6.3 The module should be kept into anti-static bags or other containers resistant to static for storage.

13.7. Limited Warranty

13.7.1 Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.

13.7.2 If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.

13.7.3 After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.



14. Packaging

TBD